# TSA-220005-1

# **Technical Specifications**

# **High Power GaN Amplifier**

2 to 18 GHz, 20 Watt High Power GaN Amplifier

**EXPORT RESTRICTIONS MAY APPLY** 



#### **Fast Data Transfers**

The TSA-220005-1 amplifier provides nominal output power of 20 Watts. The amplifier uses control circuitry to ensure safe startup and automatic thermal shutdown and recovery. The amplifiers have an external pin for TTL on/off control. On/Off Low or High can be specified; standard is Off/Low.

Heat sinking is required to keep the case temperatures within a safe operating range. A thin layer of thermal grease or HiTherm (for example the HT-2500 series) helps provide a low resistance thermal path between the case and the mounting surface. The mounting surface should be metal with heat conduction of aluminum or better. Heat sink size depends on whether fan-driven air cooling is used, or if only convection is used.

### **Heat Sink Warning**

This amplifier requires an adequate heat sink to prevent damage. Maximum case temperature must not be exceeded. The package is designed to provide adequate heat transfer to proper aluminum heat sink.

#### **Typical Values**

- Broadband: 2-18 GHz
- High Saturated Power, Psat: 20 W, (43dBm)
- Small hermetric package
- Dimensions: 2.9"L x 2.0"W x 0.41"H



## **Specifications\***

Parameter	Guarenteed -55 to +85°C
Frequency (Min.)	2-18 GHz
Small Signal Gain (Min.)	54 dB
Noise Figure (Max.)	6.5 dB
SWR (Max.) Input/Output	2.0:1/2.0:1
Power Output (Min.) @ Pin5 dBm	+42 dBm (43 dBm mid-band)
Harmonics (Max.) @ Pin = -5 dBm	-10 dBc
DC Current (Max.) @ Pin = -5 dBm	5.5A (22v), 0.5A (8V) Typ.

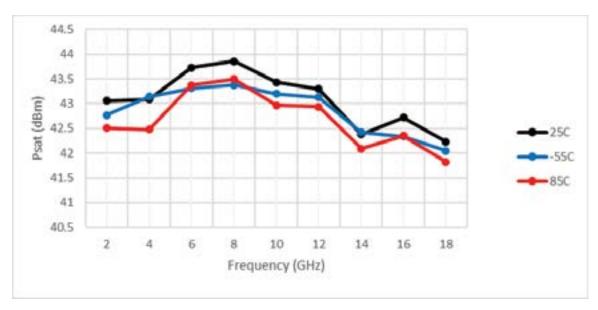
<sup>\*</sup>Measured in a 50-ohm system at +22V

#### **Absolute Maximum Ratings**

Parameter	Value
Storage Temperature	-62 to +125° <b>C</b>
Maximum Case Temperature, +29V	+85° <b>C</b>
Maximum DC Voltage	+29 Volts
Maximum RF Input Power	+20 dBm
Burn-in Temperature, +29V	+85° <b>C</b>
Thermal Resistance¹ (0jc)	+1.52°C/Watt
Junction Temperature Rise Above Case (Tjc), +29V, +25°C	+112°C

 $<sup>{}^{\</sup>scriptscriptstyle 1}\text{Thermal}$  resistance is based on total power dissipation

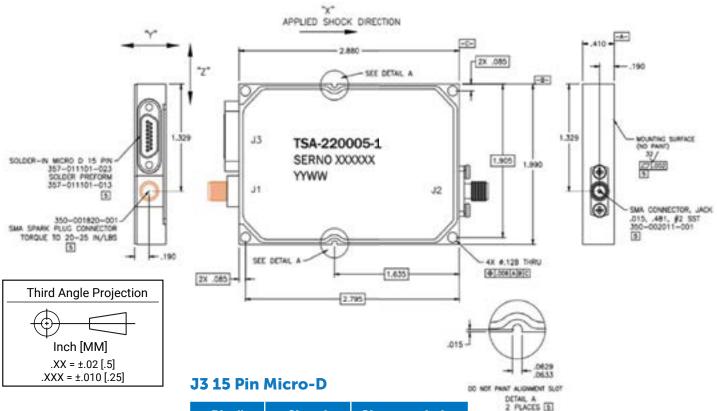
### **PSAT Performance**



<sup>^</sup> Faster switching speed option available upon request

#### **Outline Drawing - High Power GaN Amplifier**

Please contact factory for finish and outline options



Pin #	Signal	Characteristics
1-4	+22V	DC
5-8	+22V Return	DC
10	+5V	DC
11	-5V	DC
12	Return	+8V, -5V, BIT
13	Bias_EN	LVCMOS
14	Bias_EN_RTN	LVCMOS Return
9	BIT	DC Pulse
15	Spare	-

# Logic Table

TTL	State
HIGH	ON
LOW	OFF

**Notes:** (Unless otherwise specified)

- 1. Dimensions are in inches
- 2. Tolerances: X.XXX± 0.005

X.XX±0.01

- 3. Marking as shown shall be permaanent and legible per MIL-STD-130 using black epoxy base ink
- 4. Case material: Aluminum
- 5. Finish: All surfaces except mounting surface, connectors and pins, alignment slots and Micro-D connector, are painted with epoxy paint per MIL-C-22750 over epoxy primer per MIL-P-23377, Type I. Color is Teledyne standard color chip 26231 per FED-STD-595 mounting surface is Chem Film per MIL-DTL-5541, Class 3, Type I.
- 6. Weight not to exceed 0.40 pounds

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